

# 2SK2572(Tentative)

## Silicon N-Channel Power F-MOS

### ■ Features

- Avalanche energy capability guaranteed
- High-speed switching
- Low ON-resistance
- No secondary breakdown

### ■ Applications

- Non-contact relay
- Solenoid drive
- Motor drive
- Control equipment
- Switching mode regulator

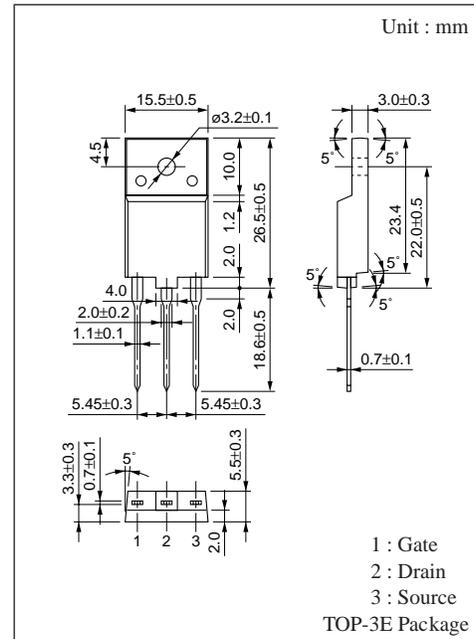
### ■ Absolute Maximum Ratings (T<sub>c</sub> = 25°C)

Parameter	Symbol	Rating	Unit	
Drain-Source breakdown voltage	V <sub>DSS</sub>	500	V	
Gate-Source voltage	V <sub>GSS</sub>	±20	V	
Drain current	DC	I <sub>D</sub>	±15	A
	Pulse	I <sub>DP</sub>	±30	A
Avalanche energy capability	EAS*	11.25	mJ	
Allowable power dissipation	T <sub>c</sub> = 25°C	P <sub>D</sub>	100	W
	T <sub>a</sub> = 25°C		3	
Channel temperature	T <sub>ch</sub>	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	

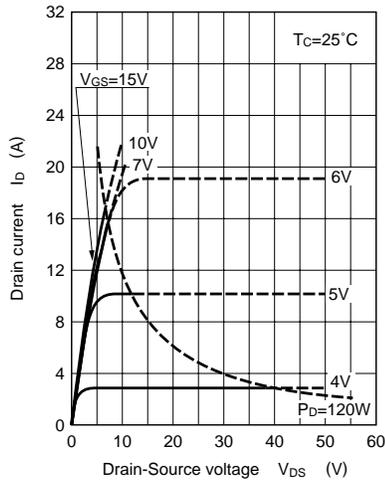
\* L= 0.1mH, I<sub>L</sub>=15A, 1 pulse

### ■ Electrical Characteristics (T<sub>c</sub> = 25°C)

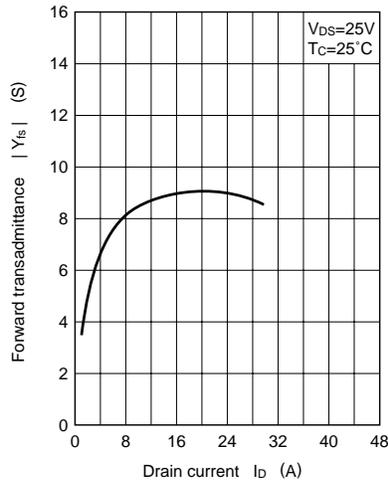
Parameter	Symbol	Condition	Min	Typ	Max	Unit	
Drain-Source cut-off current	I <sub>DSS</sub>	V <sub>DS</sub> = 400V, V <sub>GS</sub> = 0			100	μA	
Gate-Source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =±30V, V <sub>DS</sub> = 0			±1	μA	
Drain-Source breakdown voltage	V <sub>DSS</sub>	I <sub>D</sub> =1mA, V <sub>GS</sub> = 0	500			V	
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 25V, I <sub>D</sub> =1mA	1		5	V	
Drain-Source ON-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> = 8A		0.38	0.5	Ω	
Forward transadmittance	Y <sub>fs</sub>	V <sub>DS</sub> = 25V, I <sub>D</sub> = 8A	5	8		S	
Diode forward voltage	V <sub>DSF</sub>	I <sub>DR</sub> =15A, V <sub>GS</sub> = 0			-1.8	V	
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0, f=1MHz		1500		pF	
Output capacitance	C <sub>oss</sub>				300		pF
Feedback capacitance	C <sub>rss</sub>				145		pF
Turn-on time	t <sub>on</sub>	V <sub>DD</sub> =150V, I <sub>D</sub> = 8A V <sub>GS</sub> =10V, R <sub>L</sub> =19Ω		110		ns	
Fall time	t <sub>f</sub>				100		ns
Turn-off time (delay time)	t <sub>d(off)</sub>				330		ns
Channel-Case heat resistance	R <sub>th(ch-c)</sub>				1.25	°C/W	
Channel-Atmosphere heat resistance	R <sub>th(ch-a)</sub>				41.67	°C/W	



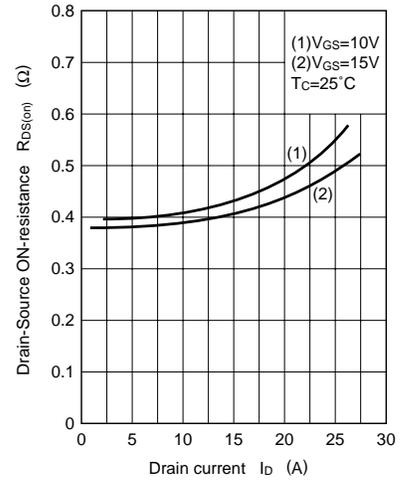
$I_D - V_{DS}$



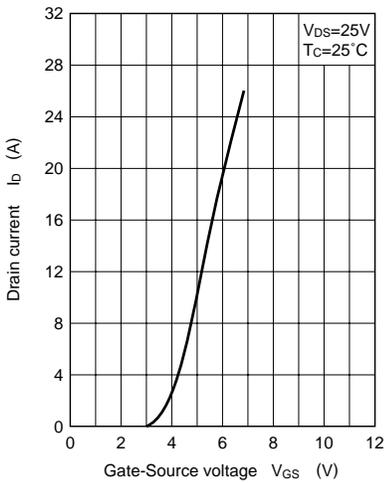
$|Y_{fs}| - I_D$



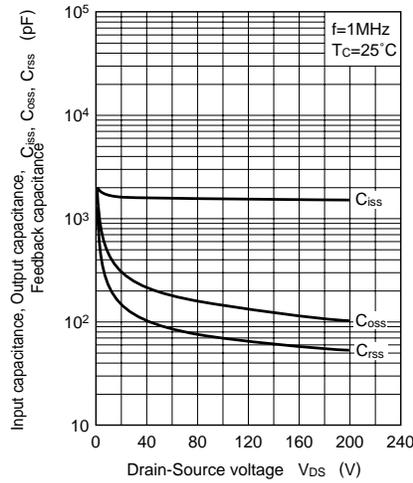
$R_{DS(on)} - I_D$



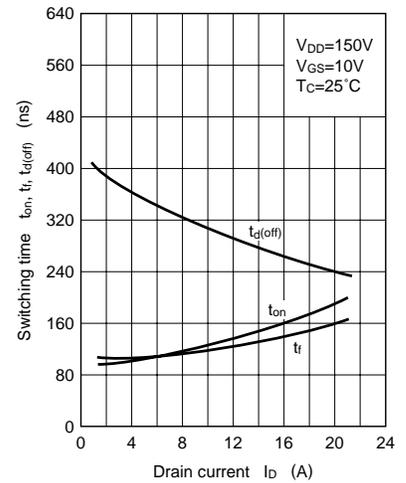
$I_D - V_{GS}$



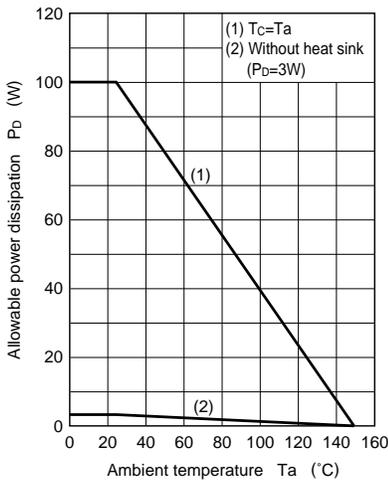
$C_{iss}, C_{oss}, C_{rss} - V_{DS}$



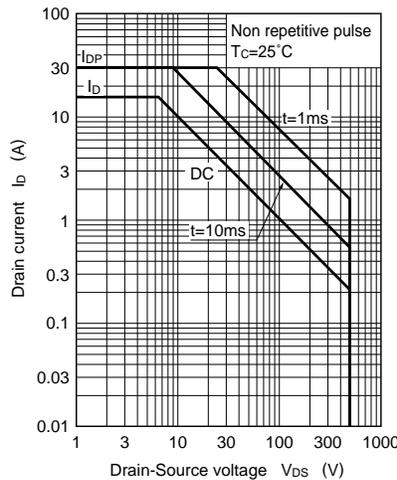
$t_{on}, t_f, t_d(off) - I_D$



$P_D - T_a$



Area of safe operation (ASO)



$R_{DS(on)} - I_D$

